

#### 1.8 INCH SERIAL ATA PLUG

#### 1.0 SCOPE

This Product Specification covers the performance requirements of the Serial ATA / High Speed Serialized device plug connector.

#### 2.0 PRODUCT DESCRIPTION

### 2.1 PRODUCT NAME AND SERIES NUMBER(S)

Product Name Part Number

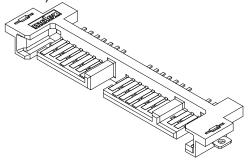
SATA PLUG, 1.8 INCH SSD RIGHT ANGLE SMT 78285-0001

## 2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See Sales Drawing SD-78285-001 for information on dimensions, materials, platings and markings.

#### 2.3 SAFETY AGENCY APPROVALS

UL FILE: E29179 (VOLUME 10) CSA: 1699307 (LR19980)



#### 3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

The following documents form a part of this specification to the extend specified herewith. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In addition, in event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

**SATA Specification** 

#### TENTATIVE RELEASE:

THIS SPECIFICATION IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE.
PRELIMINARY TEST DATA MAY EXIST, BUT THIS SPECIFICATION IS SUBJECT TO CHANGE
BASED ON THE RESULTS OF ADDITIONAL TESTING AND EVALUATION

REVISION:	ECR/ECN INFORMATION:	TITLE: SEI	RIAL ATA PLUG		SHEET No.
3	EC No: <b>S2010-0563</b>	,	1.8 INCH SSD		<b>1</b> of <b>7</b>
<b>)</b>	DATE: 2010/01/18	RIG	HT-ANGLE SMT		1017
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PS-78285-002		Victor Lim 2010/01/18	Colynn Goh 2010/01/27	B.O Kok	2010/01/27



## 4.0 RATINGS

## 4.1 VOLTAGE

30 Volts Max

#### **4.2 CURRENT**

1.5 Amps DC or AC (RMS) Max @ 60 Hz

## 4.3 TEMPERATURE

Operating: - 0°C to + 55°C Non Operating: - 40°C to + 85°C

## 4.4 HUMIDITY

20% - 80%

#### 4.5 PRESSURE

650 mm – 800 mm Hg

## **5.0 PERFORMANCE**

#### **5.1 ELECTRICAL REQUIREMENTS**

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
1	Low Level Contact Resistance (LLCR)	Subject mated contacts assembled in housing to <b>20</b> mV maximum open circuit at <b>100</b> mA maximum. (EIA 364-23)	30 mΩ MAXIMUM [Initial]  15 mΩ  MAXIMUM [Delta change from Initial]
2	Contact Current Rating (Power Segment)	Mount connector to a test PCB with ½ oz copper layer. Wire power pins P1, P2, P5 and P6 in parallel for power. Wire ground pins P3 and P4 in parallel for return. Supply 6A total DC current to the power pins in parallel, returning from the parallel ground pins (P3, and P4). Record temperature rise when thermal equilibrium is reach.	1.5 A per pin MINIMUM  Temperature rise shall not exceed 30°C at any point in the connector when contacts are powered  Still Air at Ambient temperature 25°C
3	Insulation Resistance	Apply a voltage of <b>500</b> VDC for <b>1</b> minute between adjacent terminals. Measure the insulation resistance for mated and unmated connectors (EIA 364-21)	<b>1000</b> ΜΩ ΜΙΝΙΜUΜ

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4	Dielectric Withstanding Voltage	Apply a voltage of <b>500</b> VAC for <b>1</b> minute between adjacent terminals of mated and unmated connectors. (EIA 364-20 Method B)	No breakdown
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## **5.2 MECHANICAL REQUIREMENTS**

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
5	Connector Insertion and Removal Forces	Mate and Unmate connector assemblies at a rate of <b>12.5</b> mm per minute. (EIA 364-13)	20 N MAXIMUM insertion force &  2.5 N MINIMUM removal force [Intial & After 500 cycles]
6	Durability	<b>500</b> cycles for backplane/blindmate application. All at a maximum rate of <b>200</b> cycles per hour. (EIA 364-09)	No Physical damage  Meet requirements of additional tests as specified in the test sequence in Section 7.0
7	Solder tab Retention Force	Apply axial pull out force on solder tab in the housing at a rate of <b>25.4</b> mm per minute.	4.45 N MINIMUM retention force
8	Physical Shock	Subject mated connector to <b>30</b> g's half-sine shock pulses of <b>11</b> msec duration. Three shocks in each direction applied along three mutually perpendicular planes for a total of <b>18</b> shocks.  (EIA 364-27 Condition H)	No Physical damage No discontinuities of 1 μs or longer duration
9	Random Vibration	Subject mated connector to <b>5.35</b> g's RMS. <b>30</b> minutes in each of the three mutually perpendicular planes. (EIA 364-28 Condition V Test letter A)	No discontinuities of 1 μs or longer duration

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## **5.3 ENVIRONMENTAL REQUIREMENTS**

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT		
10	Humidity	Subject the connector to temperature and humidity of <b>40</b> °C at <b>95</b> % RH for <b>96</b> hours. (EIA 364-31 Method II Test Condition A)	No Physical damage  Meet requirements of additional tests as specified in the test sequence in Section 7.0		
11	Resistance to Soldering Heat	Refer to Section 9.0 for soldering profile	No damage in appearance of connector		
12	Solderability	Solder Time : $3 \pm 0.5$ seconds Solder Temperature : $260 \pm 5^{\circ}$ C	<b>95</b> % MIN Solder coverage		
13	Temperature Life	Subject mated connector to temperature life at <b>+85</b> °C for <b>500</b> hours. (EIA 364-17 Test Condition III Method A)	No Physical damage  Meet requirements of additional tests as specified in the test sequence in Section 7.0		
14	Thermal Shock	Subject connector to <b>10</b> cycles between <b>-55°</b> C and <b>+85°</b> C. (EIA 364-32 Test Condition I)	No Physical damage  Meet requirements of additional tests as specified in the test sequence in Section 7.0		
15	Mixed Flowing Gas	Half of the samples are exposed unmated for 7 days, then mated for the remaining 7 days. The other half of the samples mated for full 14 days test period. (EIA 364-65, Class 2A)	No Physical damage  Meet requirements of additional tests as specified in the test sequence in Section 7.0		

## **6.0 PACKAGING**

Refer to Sales Drawing SD-78285-001 for packing details.

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## 7.0 TEST SEQUENCES

Test Group →	Α	В	С	D	Е	F	G	Н
Test or Examination <b>Ψ</b>								
Examination of the connector(s)	1, 5	1, 9	1, 8	1, 8	1, 7	1	1, 5	
Low Level Contact Resistance (LLCR)	2, 4	3, 7	2, 4, 6		4, 6			
Insulation Resistance				2, 6				
Dielectric Withstanding Voltage				3, 7				
Current Rating			7					
Insertion Force		2					2	
Removal Force		8					4	
Durability	3	4 <sup>(a)</sup>			2 <sup>(a)</sup>		3	
Physical Shock		6						
Vibration		5						
Humidity				5				
Temperature Life			3					
Reseating (manually unplug/plug three times)			5		5			
Mixed Flowing Gas					3			
Thermal Shock				4				
Resistance to Soldering Heat						3		
Solder Tab Retention Force						2, 4		
Solderability								1

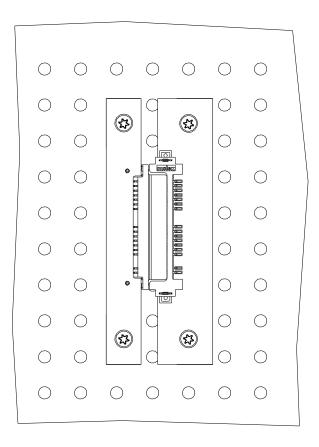
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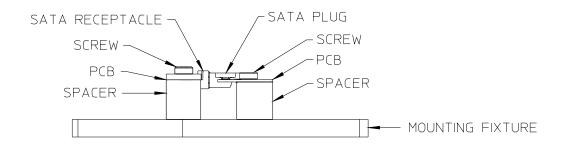
(a) Preconditioning, 50 cycles for the 500-durability cycles requirement. The insertion and removal cycle is at a maximum rate of 200 cycles per hour.

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PS-78285-002		Victor Lim 2010/01/18   Colynn Goh 2010/01/27   B.O K		B.O Kok	2010/01/27



## 8.0 VIBRATION/SHOCK TEST SET-UP

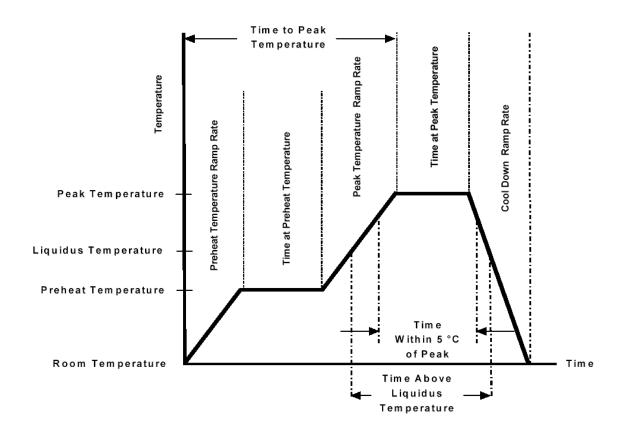




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## 9.0 SOLDERING PROFILE



Description	Requirement
Average Ramp Rate	3°C/sec Max
Preheat Temperature	150°C Min to 200°C Max
Preheat Time	60 to 180 sec
Ramp to Peak	3°C/sec Max
Time over Liquidus (217°C)	60 to 150 sec
Peak Temperature	260 +0/-5°C
Time within 5°C of Peak	20 to 40 sec
Ramp - Cool Down	6°C/sec Max
Time 25°C to Peak	8 min Max

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